

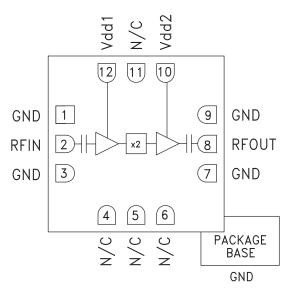
# SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 13 - 24.6 GHz OUTPUT

# **Typical Applications**

The HMC814LC3B is ideal for:

- Clock Generation Applications: SONET OC-192 & SDH STM-64
- Point-to-Point & VSAT Radios
- Test Instrumentation
- Military & Space
- Sensors

### Functional Diagram



# Features

High Output Power: +17 dBm Low Input Power Drive: 0 to +6 dBm Fo Isolation: >20 dBc @ Fout = 19 GHz 100 kHz SSB Phase Noise: -136 dBc/Hz Single Supply: +5V @ 88 mA 12 Lead 3x3 mm SMT Package: 9 mm<sup>2</sup>

## **General Description**

The HMC814LC3B is a x2 active broadband frequency multiplier utilizing GaAs pHEMT technology in a leadless RoHS compliant SMT package. When driven by a +4 dBm signal, the multiplier provides +17 dBm typical output power from 13 to 24.6 GHz. The Fo, 3Fo and 4Fo isolations are >20 dBc at 19 GHz. The HMC814LC3B is ideal for use in LO multiplier chains for Pt-to-Pt & VSAT Radios yielding reduced parts count vs. traditional approaches. The low additive SSB Phase Noise of -136 dBc/Hz at 100 kHz offset helps maintain good system noise performance. The RoHS packaged HMC814LC3B eliminates the need for wire bonding, and allows the use of surface mount manufacturing techniques.

### Electrical Specifications, $T_{A} = +25^{\circ}$ C, Vdd1, Vdd2 = +5V, +4 dBm Drive Level

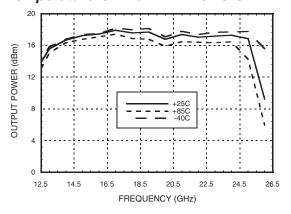
Parameter	Min.	Тур.	Max.	Units
Frequency Range, Input		6.5 - 12.3 GHz		
Frequency Range, Output		13 - 24.6		
Output Power	14	17		dBm
Fo Isolation (with respect to output level)		25		dBc
3Fo Isolation (with respect to output level)		25		dBc
Input Return Loss	4	10		dB
Output Return Loss	6	12		dB
SSB Phase Noise (100 kHz Offset @ Input Frequency = 19 GHz)		-136		dBc/Hz
Supply Current (Idd1 & Idd2)	70	88	100	mA



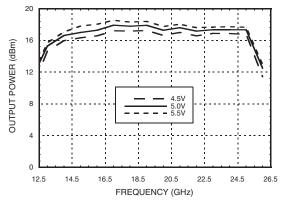


SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 13 - 24.6 GHz OUTPUT

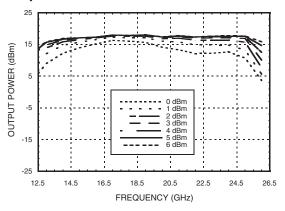
Output Power vs. Temperature @ +4 dBm Drive Level



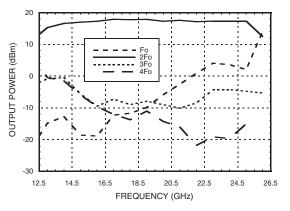
Output Power vs. Supply Voltage @ +4 dBm Drive Level

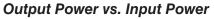


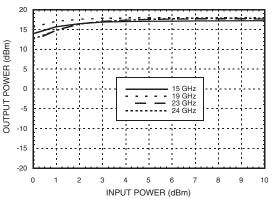
**Output Power vs. Drive Level** 



Isolation @ +4 dBm Drive Level





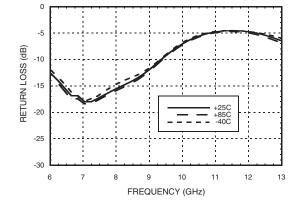




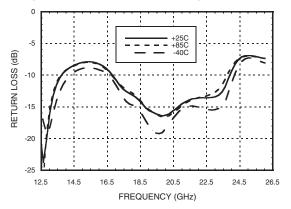


# SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 13 - 24.6 GHz OUTPUT

#### Input Return Loss vs. Temperature



#### Output Return Loss vs. Temperature



Phase Noise @ 19 GHz -10 -30 PHASE NOISE (dBc/Hz) -50 -70 -90 -11 -13 -150 -170 10<sup>3</sup> 10<sup>5</sup> 10<sup>6</sup> 10<sup>7</sup> 10<sup>8</sup> 10<sup>2</sup> 10' FREQUENCY (Hz)





# SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 13 - 24.6 GHz OUTPUT

## Absolute Maximum Ratings

RF Input (Vdd = +5V)	+10 dBm	
Supply Voltage (Vdd1, Vdd2)	+5.5 Vdc	
Channel Temperature	175 °C	
Continuous Pdiss (T= 85 °C) (derate 8.3 mW/°C above 85 °C)	743 mW	
Thermal Resistance (channel to ground paddle)	121 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 0 (Passed 150 V)	

# Typical Supply Current vs. Vdd

Vdd (Vdc)	ldd (mA)
4.5	87
5.0	88
5.5	89

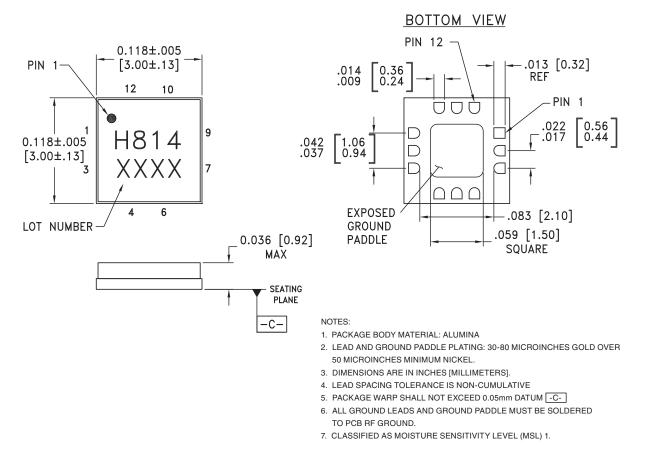
#### Note:

Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

## **Outline Drawing**



FREQ. MULTIPLIERS - ACTIVE - SMT

5





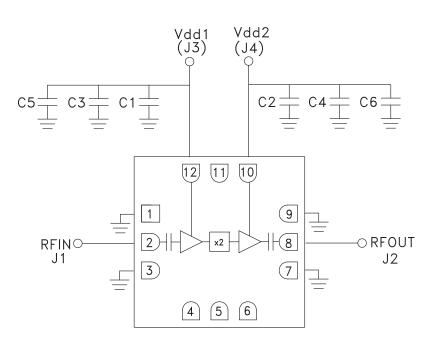
# SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 13 - 24.6 GHz OUTPUT

### **Pin Description**

Pin Number	Function	Description	Interface Schematic
1, 3, 7, 9	GND	Package bottom must also be connected to RF/DC ground.	
2	RFIN	This pin is AC coupled and matched to 50 Ohms.	
4 - 6, 11	N/C	These pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/ DC ground.	
8	RFOUT	This pin is AC coupled and matched to 50 Ohms.	
10, 12	Vdd2, Vdd1	Supply voltage 5V $\pm$ 0.5V. External bypass capacitors of 100 pF, 1,000 pF and 2.2 $\mu F$ are recommended.	Vdd1, Vdd2 = =

# **Application Circuit**

Component	Value
C1, C2	100 pF
C3, C4	1,000 pF
C5, C6	2.2 µF



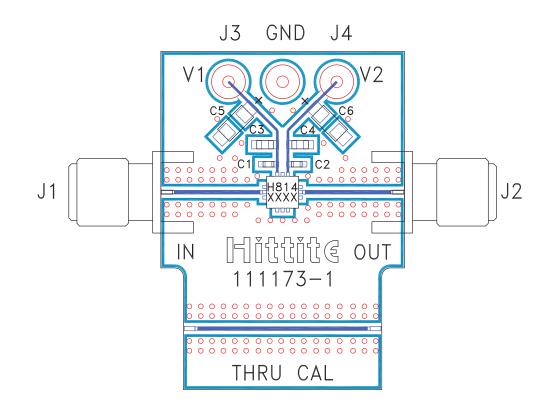






# SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 13 - 24.6 GHz OUTPUT

### **Evaluation PCB**



### List of Materials for Evaluation PCB 112409<sup>[1]</sup>

Item	Description
J1, J2	PCB Mount SRI K Connector
J3 - J5	DC Pin
C1, C2	100 pF Capacitor, 0402 Pkg.
C3, C4	1,000 pF Capacitor, 0603 Pkg.
C5, C6	2.2 µF Tantalum Capacitor
U1	HMC814LC3B x2 Active Multiplier
PCB [2]	111173 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25FR

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.